

#### NCE P-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE60P50K uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge .This device is well suited for high current load applications.

#### **General Features**

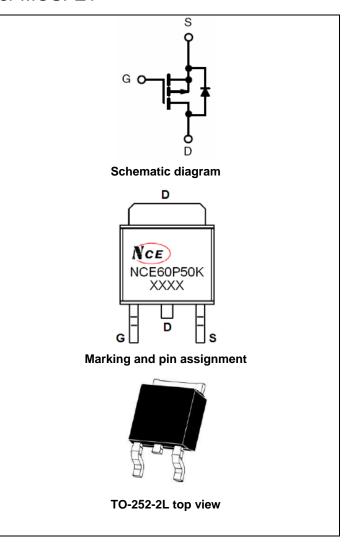
- $V_{DS}$  =-60V, $I_{D}$  =-50A  $R_{DS(ON)}$  <28m $\Omega$  @  $V_{GS}$ =-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

# **Application**

Load switch

100% UIS TESTED!

100% AVds TESTED!



#### **Package Marking and Ordering Information**

<b>Device Marking</b>	Device	Device Package	Reel Size	Tape width	Quantity	
NCE60P50K	NCE60P50K	TO-252-2L	-	-	-	

#### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	-60	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	-50	А
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	-35	Α
Pulsed Drain Current	I <sub>DM</sub>	-150	Α
Maximum Power Dissipation	P <sub>D</sub>	95	W
Derating factor		0.76	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	722	mJ
Operating Junction and Storage Temperature Range	$T_J,T_STG$	-55 To 150	$^{\circ}$



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# NCE60P50K

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>eJC</sub>	1.31	°C/W	1
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# Electrical Characteristics (T<sub>C</sub>=25 °C unless otherwise noted)

Off Characteristics  Drain-Source Breakdown Voltage  Zero Gate Voltage Drain Current  Gate-Body Leakage Current  On Characteristics (Note 3)  Gate Threshold Voltage  Drain-Source On-State Resistance  Forward Transconductance  Dynamic Characteristics (Note4)	$V_{DS}$ =-60V, $V_{GS}$ =0V $V_{GS}$ =±20V, $V_{DS}$ =0V $V_{DS}$ = $V_{GS}$ , $I_{D}$ =-250 $\mu$ A	-60 - - - -2.0	-2.6	- -1 ±100	V µA nA
	V <sub>DS</sub> =-60V,V <sub>GS</sub> =0V V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A	-2.0	-2.6	-1	μA
	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A	-2.0	-2.6		-
	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A			±100	nA
	V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A				
Drain-Source On-State Resistance R <sub>DS(ON</sub> Forward Transconductance g <sub>FS</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A				
Forward Transconductance g <sub>FS</sub>		-	00	-3.5	V
3,0	V <sub>DS</sub> =-10V,I <sub>D</sub> =-20A		23	28	mΩ
Dynamic Characteristics (Note4)		-	25	-	S
Input Capacitance C <sub>lss</sub>	\/ 05\/\/ 0\/	-	6460	-	PF
Output Capacitance Coss	$V_{DS}$ =-25V, $V_{GS}$ =0V, F=1.0MHz	-	719	-	PF
Reverse Transfer Capacitance C <sub>rss</sub>	F=1.0WIDZ	-	535	-	PF
Switching Characteristics (Note 4)					
Turn-on Delay Time t <sub>d(on)</sub>		-	15	-	nS
Turn-on Rise Time t <sub>r</sub>	$V_{DD}$ =-30V, $R_L$ =1.5 $\Omega$ ,	-	17	-	nS
Turn-Off Delay Time t <sub>d(off)</sub>	$V_{GS}$ =-10V, $R_{G}$ =3 $\Omega$	-	40	-	nS
Turn-Off Fall Time t <sub>f</sub>		-	45	-	nS
Total Gate Charge Q <sub>g</sub>	V = 20 L = 20 A	-	75		nC
Gate-Source Charge Q <sub>gs</sub>	V <sub>DS</sub> =-30,I <sub>D</sub> =-20A, V <sub>GS</sub> =-10V	-	16		nC
Gate-Drain Charge Q <sub>gd</sub>	V <sub>GS</sub> =-10V	-	19		nC
Drain-Source Diode Characteristics	•	•			
Diode Forward Voltage (Note 3) V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-20A	-		-1.2	V
Diode Forward Current (Note 2)		-	-	-50	Α
Reverse Recovery Time t <sub>rr</sub>	TJ = 25°C, IF =-20A	-	50		nS
Reverse Recovery Charge Qrr	di/dt = -100A/µs(Note3)	-	59		nC
Forward Turn-On Time $t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

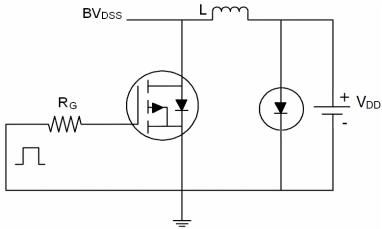
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- **4.** Guaranteed by design, not subject to production
- **5.**  $E_{AS}$  condition:  $Tj=25^{\circ}C$ ,  $V_{DD}=-30V$ ,  $V_{G}=-10V$ , L=1mH,  $Rg=25\Omega$ ,  $I_{AS}=38A$

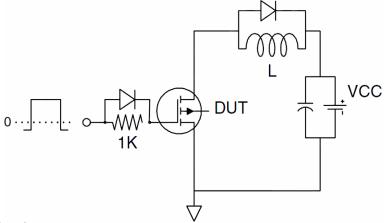
# NCE60P50K

### **Test Circuit**

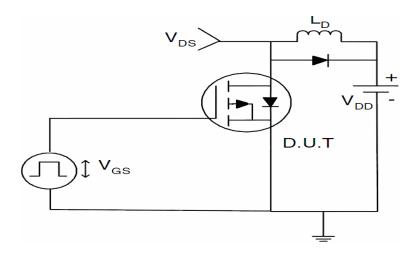
# 1) E<sub>AS</sub> Test Circuit



# 2) Gate Charge Test Circuit



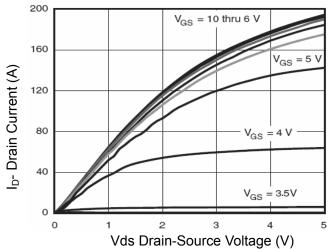
# 3) Switch Time Test Circuit



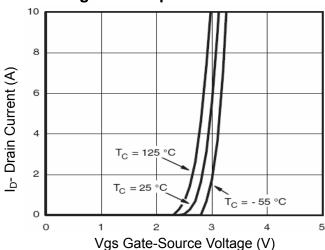
**Pb Free Product** 

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### Typical Electrical and Thermal Characteristics (Curves)



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

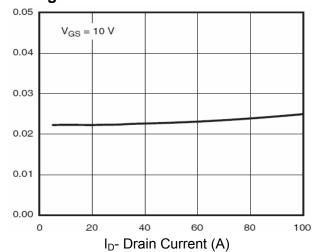
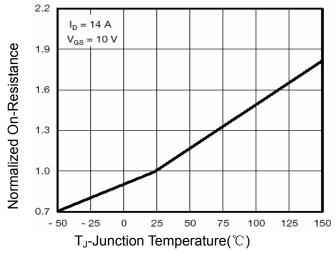


Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 

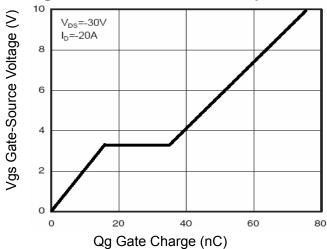


Figure 5 Gate Charge

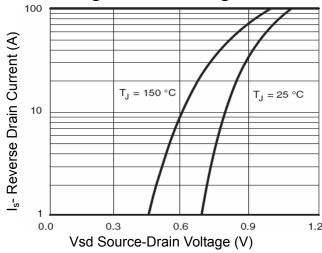
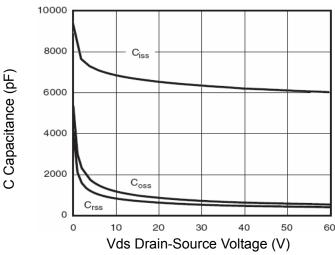
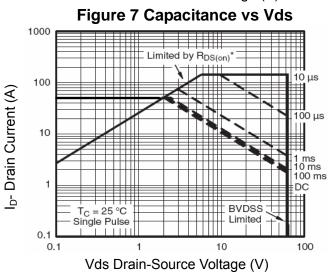


Figure 6 Source- Drain Diode Forward







**Figure 8 Safe Operation Area** 

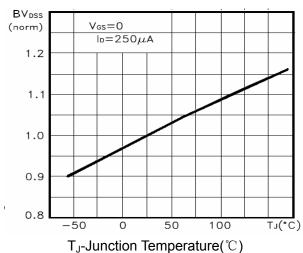


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

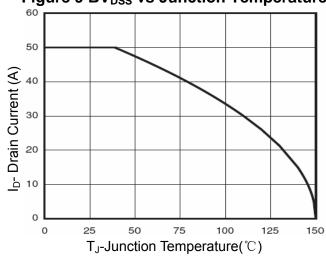
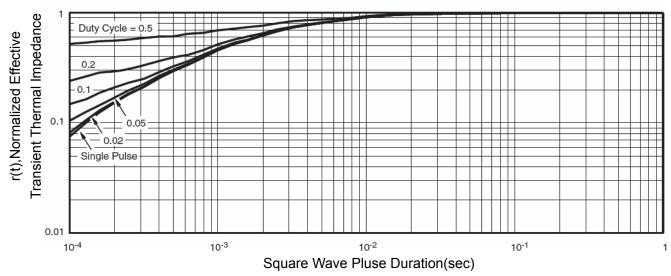


Figure 10 ID Current Derating vs Junction Temperature

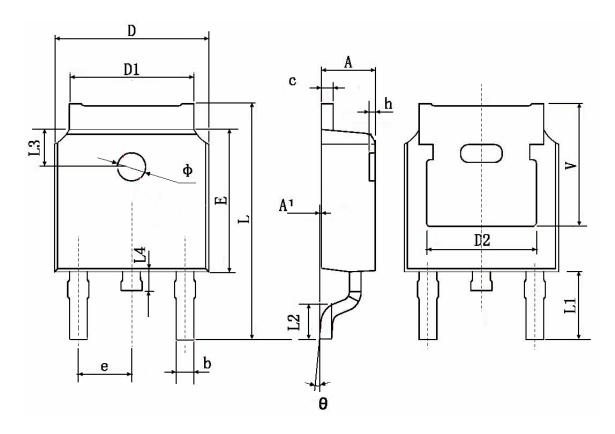


**Figure 11 Normalized Maximum Transient Thermal Impedance** 

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# NCE60P50K

# **TO-252 Package Information**



Cumbal	Dimensions	In Millimeters	Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
А	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	0.483	TYP.	0.190	TYP.		
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900 TYP.		00 TYP. 0.114 TYP.			
L2	1.400	1.700	0.055	0.067		
L3	1.600	TYP.	0.063	TYP.		
L4	0.600	1.000	0.024	0.039		
Ф	1.100	1.300	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.000	0.300	0.000	0.012		
V	5.350	TYP.	0.211	11 TYP.		



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